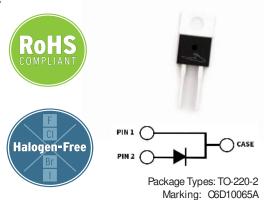


#### 6th Generation 650 V, 10 A Silicon Carbide Schottky Diode

#### **Description**

With the performance advantages of a Silicon Carbide (SiC) Schottky Barrier diode, power electronics systems can expect to meet higher e iciency standards than Si-based solutions, while also reaching higher frequencies and power densities. SiC diodes can be easily paralleled to meet various application demands, without concern of thermal runaway. In combination with the reduced cooling requirements and improved thermal performance of SiC products, SiC diodes are able to provide lower overall system costs in a variety of diverse applications.



#### **Features**

- Low Forward Voltage  $(V_{\scriptscriptstyle F})$  Drop with Positive Temperature Coe icient
- Zero Reverse Recovery Ourrent / Forward Recovery Voltage
- Temperature-Independent Switching Behavior

#### **Applications**

- Industrial Switched Mode Power Supplies
- Uninterruptible & AUX Power Supplies
- Boost for PFC & DC-DC Stages
- Solar Inverters

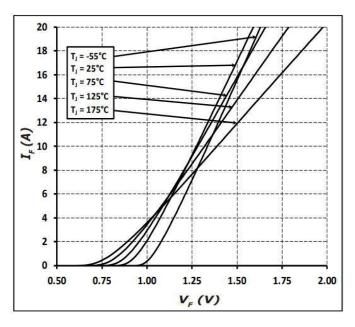
# **Maximum Ratings** ( $T_C = 25^{\circ}C$ Unless Otherwise Specified)

Parameter	Symbol	Value	Unit	Test Conditions	Notes	
Repetitive Peak Reverse Voltage	V <sub>RRM</sub>	650				
DC Blocking Voltage	V <sub>DC</sub>	650	V			
		37		T <sub>J</sub> = 25 °C		
Continuous Forward Current	l <sub>F</sub>	19	А	T <sub>J</sub> = 125 °C	Fig. 3	
		10		T <sub>J</sub> = 155 °C		
Repetitive Peak Forward Surge Current	I <sub>FRM</sub>	45		$T_{\rm C} = 25$ °C, $t_{\rm p} = 10$ ms, Half Sine Wave		
		27		$T_{\rm C} = 110 {\rm ^{\circ}C}$ , $t_{\rm p} = 10 {\rm ms}$ , Half Sine Wave		
Non-Repetitive Forward Surge Current	I <sub>FSM</sub>	86		$T_{\rm C} = 25$ °C, $t_{\rm p} = 10$ ms, Half Sine Wave		
		75		T <sub>C</sub> = 110 °C,t <sub>p</sub> = 10 ms, Half Sine Wave	Fig. 8	
Non-Repetitive Peak Forward Surge Current	 F,Max	1250		$T_{\rm C} = 25 {\rm ^{\circ}C}, t_{\rm p} = 10 \mu \rm s,  Pulse$		
		1100		T <sub>C</sub> = 110°C, t <sub>p</sub> = 10 μs, Pulse		
Power Dissipation	P <sub>tot</sub>	109	W	T <sub>J</sub> = 25 °C	Fig. 4	
		47		T <sub>J</sub> = 110 °C		

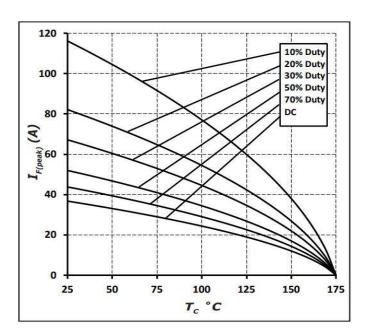
## **Electrical Characteristics**

Parameter	Symbol	Тур.	Max.	Unit	Test Conditions	Notes
Forward Voltage		1.27	1.50	V	I <sub>F</sub> = 10 A, T <sub>j</sub> = 25 °C	
	V <sub>F</sub>	1.37	1.60		I <sub>F</sub> = 10 A, T <sub>j</sub> = 175 °C	Fig. 1
Reverse Current		2	50	μА	V <sub>R</sub> = 650 V, T <sub>j</sub> = 25 °C	
	I <sub>R</sub>	15	200		$V_R = 650 \text{ V}, T_j = 175 \text{ °C}$	Fig. 2
Total Capacitive Charge	Q <sub>c</sub>	34		nC	$V_{R} = 400 \text{ V}, T_{j} = 25 \text{ °C}$	Fig. 5
		611			$V_{R} = 0 \text{ V}, T_{j} = 25 \text{ °C}$	
Total Capacitance	С			pF		

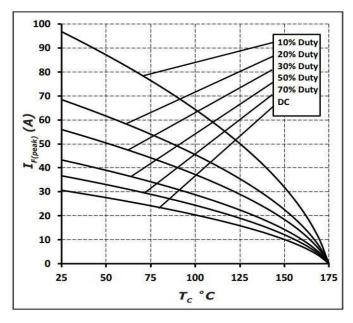
## **Typical Performance**



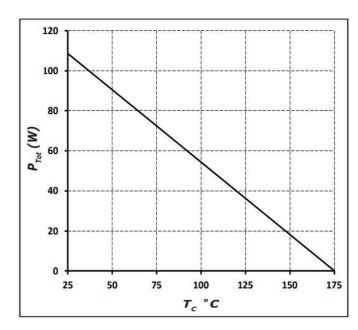
**Figure 1**Forward Characteristics



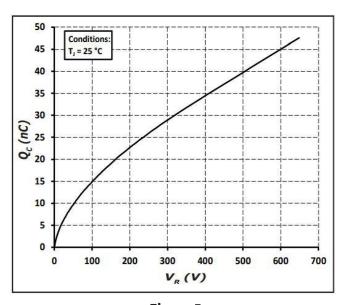
**Figure 2**Peverse Characteristics



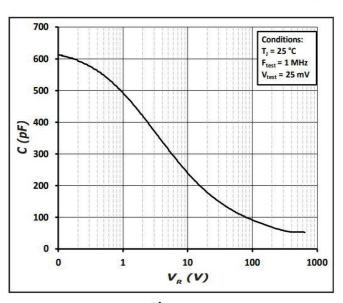
**Figure 3**Current Derating



**Figure 4**Power Derating



**Figure 5**Total Capacitance vs. Reverse Voltage



**Figure 6**Capacitace vs. Reverse Voltage

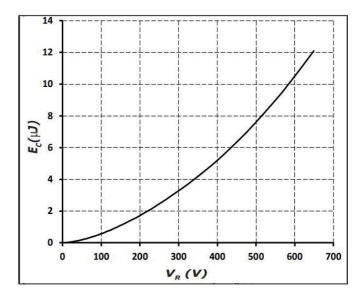
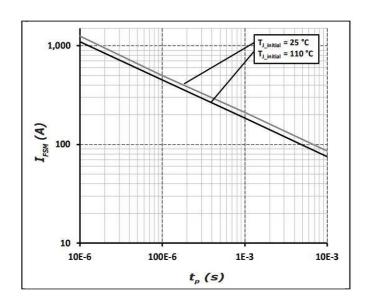


Figure 7
Capacitance Stored Energy



**Figure 8**Non-Repetitive Peak Forward Surge Current versus Pulse Duration (sinusoidal waveform)

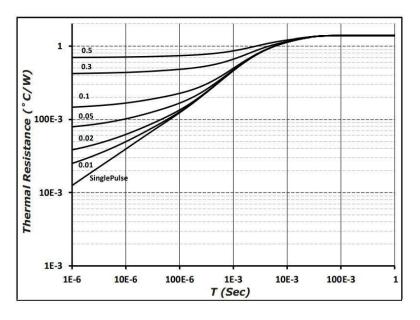
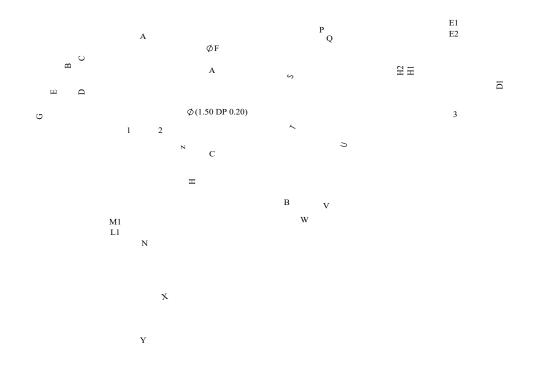


Figure 9
Transient Thermal Impedance

Rev. 1, March 2023

## Package Dimensions & Pin-Out

Package: TO-220-2



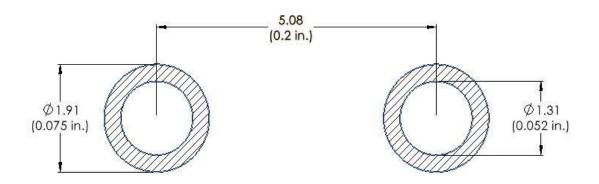
#### NOTE

- $\begin{array}{l} {\rm 1.\;ALL\;METAL\;SURFACES\;ARE\;TIN\;PLATED\;(MATTE),} \\ {\rm EXCEPT\;AREA\;OF\;CUT.} \end{array}$
- $\begin{tabular}{ll} 2. & DIMENSIONING \& TOLERANCING CONFORM TO \\ & ASME Y14.5M-1994. \end{tabular}$
- 3. ALL DIMENSIONS ARE LISTED IN MILLIMETERS. ANGLES ARE IN DEGREES.
- 4. PACKAGE BURR FLASH SIZE (0.5 mm) IS NOT INCLUDED IN THE DIMENSIONS



# **Recommended Solder Pad Layout**

Primary dimensions shown in mm.



# **Product Ordering Information**

Order Number	Packing Type
C6D10065A	Tube

# **Revision History**

Document Version	Date of Release	Description of Changes
0	April-2019	Initial Release
1	March-2023	Update Package Drawing Update Landing Pad

#### Notes & Disclaimer

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#### **Contact info:**

4600 Silicon Drive Durham, NC 27703 USA Tel: +1.919.313.5300 www.wolfspeed.com/power

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